

OMG Liaison SC Agenda Berlin  
16 June, 2015

Chair: Tom Rutt - Fujitsu

## 1. Administrivia

### 1.1 Attendance:

Approval of Agenda

### 1.3 Minutes approval

Approval of minutes from the Reston meeting [liaison/15-03-01]

## 2. Disposition of Action Items:

\* Action: Bill Curtis to start preparing Explanatory Report for the automated function points submission, using pas/12-07-03 as an example. – Still Open

\*: Len Levine to prepare two explanatory reports for submitting SysML and UPDM for JTC01 PAS. – closed

## 3. Reports of existing liaisons

### 3.1 ISO/IEC JTC1

#### 3.1.1 OMG PAS Ballots

JTC1 PAS Ballots

Discuss submission plan for PAS ballots for

SysML 1.4 - Awaiting formal OMG Publication (to be submitted as DIS 19513)

UPDM 2.1 – Already published by OMG ( to be submitted as DIS 19514)

Will submit both as concurrent JTC1 PAS Ballots after SysML 1.4 is published using the Explanatory reports prepared by Len Levine

**pas/15-04-02: Explanatory Report for PAS Submission for ISO/IEC DIS 19514**  
**Information Technology**  
(Contact: Mr. Leonard F. Levine)

Explanatory Report for PAS (Publicly Available Specification) Submission for ISO/IEC DIS 19514 Information Technology – OMG Unified Profile for DoDAF and MODAF (UPDM) Version 2.1

Formats: [PDF](#), [Word](#)

**pas/15-04-01: Explanatory Report for PAS Submission for ISO/IEC DIS 19513 Information Technology**

(Contact: Mr. Leonard F. Levine)

Explanatory Report for PAS (Publicly Available Specification) Submission for ISO/IEC DIS 19513 Information Technology – OMG Systems Modeling Language (SysML)

Version 1.3

Formats: [PDF](#), [Word](#)

OMG staff needs to prepare DIS texts with the headers showing ISO/IEC DIS 19513 and ISO/IEC DIS 19514

### 3.1.2 JTC1/SC07 WG19

ISO/IEC 15414:2013, *Information technology – Open distributed processing – Reference model – Enterprise language.*

- published by both ISO and ITU-T

ISO/IEC 19793:2015 Use of UML for ODP system specifications

AMENDMENT 1 – Policy Representation

- published by both ISO and ITU-T

### 3.2 TC37 Liaison Report

#### 3.2 ISO TC184

- ISO TC184/ SC04 – Industrial Data

##### 3.2.2 ISO TC184 / SC02 – ROBOTICS -.

A new working group WG10 Modularity for Service Robots has been formed.

OMG RTC, ROIS and DDS are of interest to the WG10 modularity work.

The OMG Hardware Abstraction Layer RFP is also of interest.

## 4. Review of new and potential liaisons

## 5. Review of Plans for Standardization

o SBVR – waiting for SBVR 1.4 RTF output for a document to submit as fast track ballot under SC37 MOU.

o Automated Function Points

Bill Curtis expressed interest in progressing Automated Function Points Spec as JTC1 PAS. He still needs check with his SC07 Contacts to determine if there would be any potential problems with progression of this spec for JTC01 PAS ballot, since it is related to some of the projects currently in SC07.

Awaiting the explanatory report preparation from Bill Curtis before submitting for JTC1 PAS.

## 6 Any other business arising